

SSC8035GS6B

P-Channel Enhancement Mode MOSFET

Features

V _{DS}	V _{GS}	R _{DS(ON)} Typ.	l _D
-30V	±12V	58mΩ@-10V	
		67mΩ@-4V5	-4A
		86mΩ@-2V5	

> Description

This device is produced with high cell density DMOS trench technology, which is especially used to minimize on-state resistance. This device particularly suits low voltage applications such as portable equipment, power management and other battery powered circuits, and low in-line power dissipation are needed in a very small outline surface mount package.

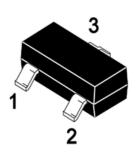
Applications

- TFT panel power switch
- Portable DVD, DPF
- High side DCDC converter
- High side driver for brushless DC motor

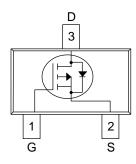
Ordering Information

Device	Package	Shipping		
SSC8035GS6B	SOT-23	3000/Reel		

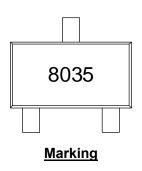
Pin configuration



SOT-23



Pin Configuration (Top View)





➤ Absolute Maximum Ratings (T_A=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
V _{DSS}	Drain-to-Source Voltage	-30	V
V _{GSS}	Gate-to-Source Voltage	±12	V
I _D	Continuous Drain Current ^a	-4	Α
I _{DM}	Pulsed Drain Current ^b	-16	Α
P _D	Power Dissipation ^c	Power Dissipation ° 1.52	
TJ	Operation junction temperature	-55~150	$^{\circ}\!\mathbb{C}$
T _{STG}	Storage temperature range	-55~150	$^{\circ}$

➤ Thermal Resistance Ratings (T_A=25°C unless otherwise noted)

Symbol	Parameter	Typical	Maximum	Unit
R _{θJA}	Junction-to-Ambient Thermal Resistance ^a	80	104	°C/W

Note:

- a. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with T_A=25°C. The value in any given application depends on the user is specific board design. The power dissipation is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P_D is based on T_{J(MAX)}=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.

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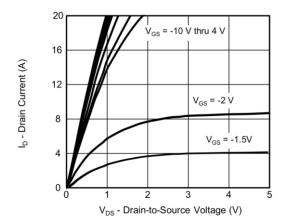
SSC8035GS6B

\succ Electrical Characteristics (T_A=25°C unless otherwise noted)

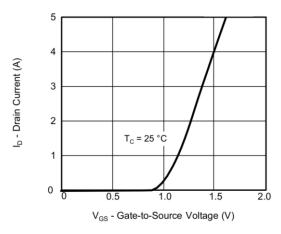
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250uA	-30			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = -250uA$	-0.5	-0.75	-1.5	V
		V _{GS} = -10V, I _D = -4A		58	75	mΩ
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = -4.5V, I _D = -2A		67	85	
		V _{GS} = -2.5V, I _D = -1A		86	120	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = -30V, V _{GS} = 0V			-1	uA
Gate-Source Leak Current	I _{GSS}	V _{GS} = ±12V, V _{DS} = 0V			±100	nA
Transconductance	GFS	V _{DS} = -5V, I _D = -3A		8		S
Forward Voltage	V _{SD}	V _{GS} = 0V, I _S = -1A		-0.8	-1.3	V
Input Capacitance	Cıss	V - 45V V - 0V		560		
Output Capacitance	Coss	$V_{DS} = -15V, V_{GS} = 0V,$		62		pF
Reverse Transfer Capacitance	Crss	f = 1MHz		52		
Turn-on Delay Time	T _{D(ON)}			9.5		
Rise Time	Tr	V_{GS} = -10V, V_{DS} = -15V, R_L = 4Ω , R_G = 3Ω		8		ns
Turn-off Delay Time	T _{D(OFF)}			31		
Fall Time	T _f			23		
Total Gate Charge	Q _G	V _{GS} = -10V, V _{DS} = -15V,		11		
Gate to Source Charge	Q _G s			2.4		nC
Gate to Drain Charge	Q _{GD}	I _D = -4A		2.8		



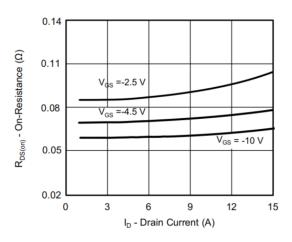
➤ Typical Performance Characteristics (T_A=25°C unless otherwise noted)



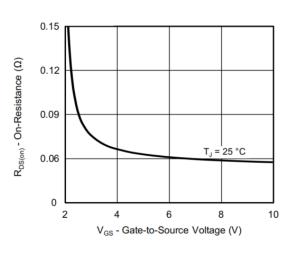
Output Characteristics



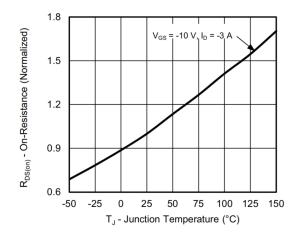
Transfer Characteristics



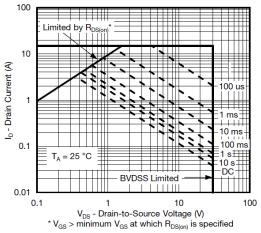
On-Resistance vs. Drain Current and Gate Voltage



On-Resistance vs. Gate-to-Source Voltage



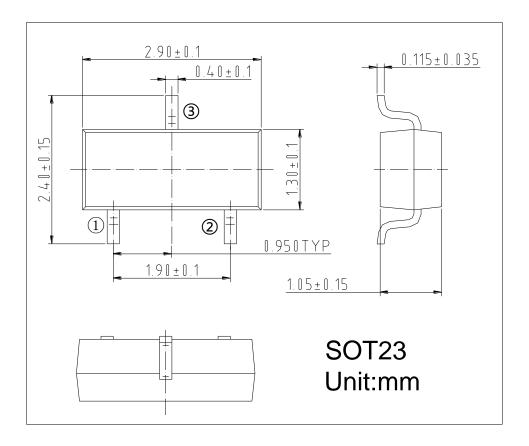
On-Resistance vs. Junction Temperature



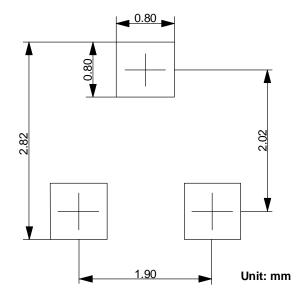
Safe Operating Area, Junction-to-Ambient



Package Information



> Suggested Pad Layout





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